Output Limiting, Ultra High Speed Programmable Gain, Buffer Amplifier

## Features

- This Circuit is Processed in Accordance to MIL-STD883 and is Fully Conformant Under the Provisions of Paragraph 1.2.1.
- User Programmable Output Voltage Limiting
- User Programmable For Closed-Loop Gains of +1, -1 or +2 Without Use of External Resistors
- Low Differential Gain and Phase . . . 0.02\%/0.04 Deg.
- Low Distortion (HD3, 30MHz) . . . . . . . . . . -73dBc (Typ)
- Wide -3dB Bandwidth . . . . . . . . . . . . . . . 850MHz (Typ)
- Very High Slew Rate . . . . . . . . . . . . . . . 2400V/ $\mu \mathrm{s}$ (Typ)
- Fast Settling (0.1\%) . . . . . . . . . . . . . . . . . . . . 13ns (Typ)
- Excellent Gain Flatness (to 100MHz) . . . . 0.07dB (Typ)
- Excellent Gain Accuracy. . . . . . . . . . . . . . . 0.99V/V (Typ)
- High Output Current . . . . . . . . . . . . . . . . . 60mA (Typ)
- Fast Overdrive Recovery. . . . . . . . . . . . . . . . <1ns (Typ)


## Applications

- Video Switching and Routing
- Pulse and Video Amplifiers
- Wideband Amplifiers
- RF/IF Signal Processing
- Flash A/D Driver
- Medical Imaging Systems


## Description

The HFA1113/883 is a closed loop buffer featuring a high degree of gain accuracy, wide bandwidth, low distortion, and programmable output limiting. This buffer is the ideal choice for high frequency applications requiring output limiting, especially those needing ultra fast overdrive recovery times. The output limiting function allows the designer to set the maximum positive and negative output levels, thereby protecting later stages from damage or input saturation. The sub-nanosecond overdrive recovery time quickly returns the amplifier to linear operation following an overdrive condition.
Component and composite video systems will also benefit from this buffer's performance, as indicated by the excellent gain flatness, and 0.02\%/0.04 Deg. Differential Gain/Phase specifications ( $R_{L}=150 \Omega$ ).

A unique feature of the pinout allows the user to select a voltage gain of +1 , -1 , or +2 , without the use of any external components, as described in the "Design Information" section. Compatibility with existing op amp pinouts provides flexibility to upgrade low gain amplifiers, while decreasing component count. Unlike most buffers, the standard pinout provides an upgrade path should a higher closed loop gain be needed at a future date.

This amplifier is available without output limiting as the HFA1112/883. For applications requiring a standard buffer pinout, please refer to the HFA1110/883 datasheet.

## Ordering Information

| PART NUMBER | TEMPERATURE <br> RANGE | PACKAGE |
| :--- | :---: | :--- |
| HFA1113MJ $/ 883$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8 Lead CerDIP |
| HFA1113ML/883 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20 Lead Ceramic LCC |

## Pinouts



## Absolute Maximum Ratings

Voltage Between V+ and V-
12 V
Differential Input Voltage $\qquad$ . . . $\qquad$
$\qquad$
Voltage at Either Input Terminal $\qquad$ . . . . . . . . . V+ to V
Voltage at $\mathrm{V}_{\mathrm{H}}$ or $\mathrm{V}_{\mathrm{L}}$ Terminal
( $\mathrm{V}+$ ) +2 V to ( $\mathrm{V}-)-2 \mathrm{~V}$
Output Current (50\% Duty Cycle) $\qquad$
Junction Temperature. $\qquad$ $\pm 55 \mathrm{~mA}$

ESD Rating.
$+175^{\circ} \mathrm{C}$
Storage Temperature Range $\qquad$
$\qquad$ < 2000V
Lead Temperature (Soldering 10s).
$-65^{\circ} \mathrm{C} \leq T_{A} \leq+150^{\circ} \mathrm{C}$

## Thermal Information

| Thermal Resistance | $\theta_{\mathrm{JA}}$ | $\theta_{\mathrm{JC}}$ |
| :---: | :---: | :---: |
| CerDIP Package . . . . . . . . . . . . . . . | $115^{\circ} \mathrm{C} / \mathrm{W}$ | $30^{\circ} \mathrm{C} / \mathrm{W}$ |
| Ceramic LCC Package . . . . . . . . . | $75^{\circ} \mathrm{C} / \mathrm{W}$ | $23^{\circ} \mathrm{C} / \mathrm{W}$ |

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

## Operating Conditions


Operating Temperature Range.
$-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$
TABLE 1. DC ELECTRICAL PERFORMANCE CHARACTERISTICS
Device Tested at: $V_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, \mathrm{R}_{\text {SOURCE }}=0 \Omega, \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{~V}_{\text {OUT }}=0 \mathrm{~V}$, Unless Otherwise Specified.

| PARAMETERS | SYMBOL | CONDITIONS |  | GROUP A SUBGROUPS | TEMPERATURE | LIMITS |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN |  | MAX |  |
| Output Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ |  |  | 1 | $+25^{\circ} \mathrm{C}$ | -25 | 25 | mV |
|  |  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | -40 | 40 | mV |
| Power Supply Rejection Ratio | PSRRP | $\begin{aligned} & \Delta V_{\text {SUPPLY }}= \pm 1.25 \mathrm{~V}, \\ & \mathrm{~V}+=6.25 \mathrm{~V}, \mathrm{~V}-=-5 \mathrm{~V}, \\ & \mathrm{~V}+=3.75 \mathrm{~V}, \mathrm{~V}-=-5 \mathrm{~V} \end{aligned}$ |  | 1 | $+25^{\circ} \mathrm{C}$ | 39 | - | dB |
|  |  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 35 | - | dB |
|  | PSRRN | $\begin{aligned} & \Delta \mathrm{V}_{\text {SUPPLY }}= \pm 1.25 \mathrm{~V}, \\ & \mathrm{~V}_{+}=5 \mathrm{~V}, \mathrm{~V}-=-6.25 \mathrm{~V}, \\ & \mathrm{~V}_{+}=5 \mathrm{~V}, \mathrm{~V}-=-3.75 \mathrm{~V} \end{aligned}$ |  | 1 | $+25^{\circ} \mathrm{C}$ | 39 | - | dB |
|  |  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 35 | - | dB |
| Non-Inverting Input (+IN) Current | $\mathrm{I}_{\text {BSP }}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ |  | 1 | $+25^{\circ} \mathrm{C}$ | -40 | 40 | $\mu \mathrm{A}$ |
|  |  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | -65 | 65 | $\mu \mathrm{A}$ |
| +IN Common Mode Rejection | $\mathrm{CMS}_{\text {IBP }}$ | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{CM}}= \pm 2 \mathrm{~V}, \\ & \mathrm{~V}+=3 \mathrm{~V}, \mathrm{~V}-=-7 \mathrm{~V}, \\ & \mathrm{~V}_{+}=7 \mathrm{~V}, \mathrm{~V}-=-3 \mathrm{~V} \end{aligned}$ |  | 1 | $+25^{\circ} \mathrm{C}$ | - | 40 | $\mu \mathrm{A} / \mathrm{V}$ |
|  |  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | - | 50 | $\mu \mathrm{A} / \mathrm{V}$ |
| +IN Resistance | $+\mathrm{R}_{\text {IN }}$ | Note 1 |  | 1 | $+25^{\circ} \mathrm{C}$ | 25 | - | k $\Omega$ |
|  |  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 20 | - | k $\Omega$ |
| Gain ( $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ ) | $A_{V P 1}$ | $\begin{array}{\|l} \hline \mathrm{A}_{\mathrm{V}}=+1, \\ \mathrm{~V}_{\mathrm{IN}}=-1 \mathrm{~V} \text { to }+1 \mathrm{~V} \end{array}$ |  | 1 | $+25^{\circ} \mathrm{C}$ | 0.980 | 1.020 | V/V |
|  |  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 0.975 | 1.025 | V/V |
| Gain ( $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ ) | $A_{\text {VM1 }}$ | $\begin{array}{\|l} \hline A_{\mathrm{V}}=-1, \\ \mathrm{~V}_{\mathrm{IN}}=-1 \mathrm{~V} \text { to }+1 \mathrm{~V} \end{array}$ |  | 1 | $+25^{\circ} \mathrm{C}$ | 0.980 | 1.020 | V/V |
|  |  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 0.975 | 1.025 | V/V |
| Gain ( $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}_{\text {P-P }}$ ) | AVP2 | $\begin{array}{\|l} \hline \mathrm{A}_{\mathrm{V}}=+2, \\ \mathrm{~V}_{\mathrm{IN}}=-1 \mathrm{~V} \text { to }+1 \mathrm{~V} \end{array}$ |  | 1 | $+25^{\circ} \mathrm{C}$ | 1.960 | 2.040 | V/V |
|  |  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 1.950 | 2.050 | V/V |
| Output Voltage Swing | $\mathrm{V}_{\text {OP100 }}$ | $\begin{array}{\|l} \hline A_{V}=-1 \\ R_{L}=100 \Omega \end{array}$ | $\mathrm{V}_{\mathrm{IN}}=-3.2 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | 3 | - | V |
|  |  |  | $\mathrm{V}_{\text {IN }}=-2.7 \mathrm{~V}$ | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 2.5 | - | V |
|  | $\mathrm{V}_{\text {ON100 }}$ | $\begin{aligned} & \hline A_{V}=-1 \\ & R_{L}=100 \Omega \end{aligned}$ | $\mathrm{V}_{\text {IN }}=+3.2 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | -3 | V |
|  |  |  | $\mathrm{V}_{\mathrm{IN}}=+2.7 \mathrm{~V}$ | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | - | -2.5 | V |
| Output Voltage Swing | $\mathrm{V}_{\text {OP50 }}$ | $\begin{aligned} & \mathrm{A}_{\mathrm{V}}=-1 \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega \end{aligned}$ | $\mathrm{V}_{\mathrm{IN}}=-2.7 \mathrm{~V}$ | 1, 2 | $+25^{\circ} \mathrm{C},+125^{\circ} \mathrm{C}$ | 2.5 | - | V |
|  |  |  | $\mathrm{V}_{\text {IN }}=-2.25 \mathrm{~V}$ | 3 | $-55^{\circ} \mathrm{C}$ | 1.5 | - | V |
|  | $\mathrm{V}_{\text {ON50 }}$ | $\begin{aligned} & A_{V}=-1 \\ & R_{L}=50 \Omega \end{aligned}$ | $\mathrm{V}_{\mathrm{IN}}=+2.7 \mathrm{~V}$ | 1, 2 | $+25^{\circ} \mathrm{C},+125^{\circ} \mathrm{C}$ | - | -2.5 | V |
|  |  |  | $\mathrm{V}_{\text {IN }}=+2.25 \mathrm{~V}$ | 3 | $-55^{\circ} \mathrm{C}$ | - | -1.5 | V |
| Output Current | ${ }^{\text {l }}$ OUT | Note 2 |  | 1, 2 | $+25^{\circ} \mathrm{C},+125^{\circ} \mathrm{C}$ | 50 | - | mA |
|  |  |  |  | 3 | $-55^{\circ} \mathrm{C}$ | 30 | - | mA |
|  | - ${ }_{\text {OUT }}$ | Note 2 |  | 1, 2 | $+25^{\circ} \mathrm{C},+125^{\circ} \mathrm{C}$ | - | -50 | mA |
|  |  |  |  | 3 | $-55^{\circ} \mathrm{C}$ | - | -30 | mA |

## TABLE 1. DC ELECTRICAL PERFORMANCE CHARACTERISTICS (Continued)

Device Tested at: $V_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, \mathrm{R}_{\text {SOURCE }}=0 \Omega, \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{~V}_{\text {OUT }}=0 \mathrm{~V}$, Unless Otherwise Specified.

| PARAMETERS | SYMBOL | CONDITIONS | GROUP A SUBGROUPS | TEMPERATURE | LIMITS |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | MIN | MAX |  |
| Quiescent Power Supply Current | $\mathrm{I}_{\mathrm{CC}}$ | $\mathrm{R}_{\mathrm{L}}=100 \Omega$ | 1 | $+25^{\circ} \mathrm{C}$ | 14 | 26 | mA |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | - | 33 | mA |
|  | $\mathrm{I}_{\text {EE }}$ | $\mathrm{R}_{\mathrm{L}}=100 \Omega$ | 1 | $+25^{\circ} \mathrm{C}$ | -26 | -14 | mA |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | -33 | - | mA |
| Limiting Accuracy | $\mathrm{V}_{\mathrm{H}} \mathrm{CLMP}$ | $\begin{aligned} & \mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\mathrm{IN}}=-1.6 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{H}}=1 \mathrm{~V} \end{aligned}$ | 1 | $+25^{\circ} \mathrm{C}$ | -150 | 150 | mV |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | -200 | 200 | mV |
|  | V ${ }_{\text {L }}$ CLMP | $\begin{aligned} & A_{V}=-1, V_{I N}=+1.6 \mathrm{~V}, \\ & V_{L}=-1 V \end{aligned}$ | 1 | $+25^{\circ} \mathrm{C}$ | -150 | 150 | mV |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | -200 | 200 | mV |
| $\mathrm{V}_{\mathrm{H}}$ or $\mathrm{V}_{\mathrm{L}}$ Input Current | $\mathrm{V}_{\mathrm{H}} \mathrm{BIAS}$ | $\mathrm{V}_{\mathrm{H}}=1 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | 200 | $\mu \mathrm{A}$ |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | - | 300 | $\mu \mathrm{A}$ |
|  | VLBIAS | $\mathrm{V}_{\mathrm{L}}=-1 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | -200 | - | $\mu \mathrm{A}$ |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | -300 | - | $\mu \mathrm{A}$ |

NOTES:

1. Guaranteed from $+\mathbb{N}$ Common Mode Rejection Test, by: $+R_{I N}=1 / C M S_{I B P}$.
2. Guaranteed from $\mathrm{V}_{\text {OUT }}$ Test with $\mathrm{R}_{\mathrm{L}}=50 \Omega$, by: $\mathrm{I}_{\mathrm{OUT}}=\mathrm{V}_{\text {OUT }} / 50 \Omega$.

TABLE 2. AC ELECTRICAL PERFORMANCE CHARACTERISTICS
Table 2 Intentionally Left Blank.

TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS
Device Characterized at: $V_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, R_{L}=100 \Omega$, Unless Otherwise Specified.

| PARAMETERS | SYMBOL | CONDITIONS | NOTES | TEMPERATURE | LIMITS |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | MIN | MAX |  |
| -3dB Bandwidth | BW(-1) | $\mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=200 \mathrm{mV} \mathrm{V}_{\text {P-P }}$ | 1 | $+25^{\circ} \mathrm{C}$ | 450 | - | MHz |
|  | BW(+1) | $\mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=200 \mathrm{mV} \mathrm{P}_{\text {P- }}$ | 1 | $+25^{\circ} \mathrm{C}$ | 500 | - | MHz |
|  | BW(+2) | $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=200 \mathrm{mV} \mathrm{V}_{\text {P-P }}$ | 1 | $+25^{\circ} \mathrm{C}$ | 350 | - | MHz |
| Gain Flatness | GF30 | $\begin{aligned} & \mathrm{A}_{\mathrm{V}}=+2, \mathrm{f} \leq 30 \mathrm{MHz}, \\ & \mathrm{~V}_{\text {OUT }}=200 \mathrm{mV} \mathrm{~V}_{\mathrm{P}-\mathrm{P}} \end{aligned}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | $\pm 0.04$ | dB |
|  | GF50 | $\begin{aligned} & \mathrm{A}_{\mathrm{V}}=+2, \mathrm{f} \leq 50 \mathrm{MHz}, \\ & \mathrm{~V}_{\text {OUT }}=200 \mathrm{mV} \mathrm{~V}_{\mathrm{P}-\mathrm{P}} \end{aligned}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | $\pm 0.08$ | dB |
|  | GF100 | $\begin{aligned} & \mathrm{A}_{\mathrm{V}}=+2, \mathrm{f} \leq 100 \mathrm{MHz}, \\ & \mathrm{~V}_{\text {OUT }}=200 \mathrm{~m} \mathrm{~V}_{\mathrm{P}-\mathrm{P}} \end{aligned}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | $\pm 0.22$ | dB |
| Slew Rate | +SR(-1) | $\mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=5 \mathrm{~V}_{\text {P-P }}$ | 1, 2 | $+25^{\circ} \mathrm{C}$ | 1500 | - | V/us |
|  | -SR(-1) | $\mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=5 \mathrm{~V}_{\text {P-P }}$ | 1, 2 | $+25^{\circ} \mathrm{C}$ | 1800 | - | V/us |
|  | +SR(+1) | $\mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=5 \mathrm{~V}_{\text {P-P }}$ | 1, 2 | $+25^{\circ} \mathrm{C}$ | 900 | - | V/us |
|  | -SR(+1) | $\mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=5 \mathrm{~V}_{\text {P-P }}$ | 1, 2 | $+25^{\circ} \mathrm{C}$ | 800 | - | V/us |
|  | +SR(+2) | $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=5 \mathrm{~V}_{\text {P-P }}$ | 1, 2 | $+25^{\circ} \mathrm{C}$ | 1200 | - | V/us |
|  | -SR(+2) | $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=5 \mathrm{~V}_{\text {P-P }}$ | 1, 2 | $+25^{\circ} \mathrm{C}$ | 1100 | - | V/us |

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## TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS (Continued)

Device Characterized at: $V_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, R_{L}=100 \Omega$, Unless Otherwise Specified.

| PARAMETERS | SYMBOL | CONDITIONS | NOTES | TEMPERATURE | LIMITS |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | MIN | MAX |  |
| Rise and Fall Time | $\mathrm{T}_{\mathrm{R}}(-1)$ | $\mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\text {P-P }}$ | 1, 2 | $+25^{\circ} \mathrm{C}$ | - | 750 | ps |
|  | $\mathrm{T}_{\mathrm{F}}(-1)$ | $\mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\text {P-P }}$ | 1, 2 | $+25^{\circ} \mathrm{C}$ | - | 800 | ps |
|  | $\mathrm{T}_{\mathrm{R}}(+1)$ | $\mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}$ | 1, 2 | $+25^{\circ} \mathrm{C}$ | - | 750 | ps |
|  | $\mathrm{T}_{\mathrm{F}}(+1)$ | $\mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\text {P-P }}$ | 1, 2 | $+25^{\circ} \mathrm{C}$ | - | 750 | ps |
|  | $\mathrm{T}_{\mathrm{R}}(+2)$ | $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\text {P-P }}$ | 1, 2 | $+25^{\circ} \mathrm{C}$ | - | 1000 | ps |
|  | $\mathrm{T}_{\mathrm{F}}(+2)$ | $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\text {P-P }}$ | 1,2 | $+25^{\circ} \mathrm{C}$ | - | 1000 | ps |
| Overshoot | +OS(-1) | $\mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\text {P-P }}$ | 1, 3 | $+25^{\circ} \mathrm{C}$ | - | 30 | \% |
|  | -OS(-1) | $\mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}$ | 1, 3 | $+25^{\circ} \mathrm{C}$ | - | 25 | \% |
|  | +OS(+1) | $\mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}$ | 1, 3 | $+25^{\circ} \mathrm{C}$ | - | 65 | \% |
|  | -OS(+1) | $\mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}$ | 1,3 | $+25^{\circ} \mathrm{C}$ | - | 60 | \% |
|  | +OS(+2) | $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}$ | 1,3 | $+25^{\circ} \mathrm{C}$ | - | 20 | \% |
|  | -OS(+2) | $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}$ | 1,3 | $+25^{\circ} \mathrm{C}$ | - | 20 | \% |
| Settling Time | TS(0.1) | $\mathrm{A}_{\mathrm{V}}=+2$, to $0.1 \%, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}$ to 0 V | 1 | $+25^{\circ} \mathrm{C}$ | - | 20 | ns |
|  | TS(0.05) | $\begin{array}{\|l} \hline \mathrm{A}_{\mathrm{V}}=+2, \text { to } 0.05 \%, \\ \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V} \text { to } 0 \mathrm{~V} \end{array}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | 33 | ns |
| 2nd Harmonic Distortion | HD2(30) | $\begin{aligned} & A_{V}=+2, f=30 \mathrm{MHz}, \\ & V_{\text {OUT }}=2 V_{\text {P-P }} \end{aligned}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | -45 | dBc |
|  | HD2(50) | $\begin{aligned} & A_{V}=+2, f=50 \mathrm{MHz}, \\ & V_{\text {OUT }}=2 V_{\text {P-P }} \end{aligned}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | -40 | dBc |
|  | HD2(100) | $\begin{aligned} & \mathrm{A}_{\mathrm{V}}=+2, \mathrm{f}=100 \mathrm{MHz}, \\ & \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }} \end{aligned}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | -35 | dBc |
| 3rd Harmonic Distortion | HD3(30) | $\begin{aligned} & A_{V}=+2, f=30 \mathrm{MHz}, \\ & V_{\text {OUT }}=2 V_{\text {P-P }} \end{aligned}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | -65 | dBc |
|  | HD3(50) | $\begin{aligned} & \hline \mathrm{A}_{\mathrm{V}}=+2, \mathrm{f}=50 \mathrm{MHz}, \\ & \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }} \end{aligned}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | -55 | dBc |
|  | HD3(100) | $\begin{aligned} & \mathrm{A}_{\mathrm{V}}=+2, \mathrm{f}=100 \mathrm{MHz}, \\ & \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }} \end{aligned}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | -45 | dBc |

NOTES:

1. Parameters listed in Table 3 are controlled via design or process parameters and are not directly tested at final production. These parameters are lab characterized upon initial design release, or upon design changes. These parameters are guaranteed by characterization based upon data from multiple production runs which reflect lot-to-lot and within lot variation.
2. Measured between $10 \%$ and $90 \%$ points.
3. For 200ps input transition times. Overshoot decreases as input transition times increase, especially for $A_{V}=+1$. Please refer to Performance Curves.

TABLE 4. ELECTRICAL TEST REQUIREMENTS

| MIL-STD-883 TEST REQUIREMENTS | SUBGROUPS (SEE TABLE 1) |
| :--- | :---: |
| Interim Electrical Parameters (Pre Burn-In) | 1 |
| Final Electrical Test Parameters | 1 (Note 1), 2, 3 |
| Group A Test Requirements | $1,2,3$ |
| Groups C and D Endpoints | 1 |

NOTE:

1. PDA applies to Subgroup 1 only.

## Die Characteristics

DIE DIMENSIONS:
$63 \times 44 \times 19$ mils $\pm 1$ mils
$1600 \times 1130 \times 483 \mu \mathrm{~m} \pm 25.4 \mu \mathrm{~m}$
METALLIZATION:
Type: Metal 1: AICu(2\%)/TiW
Thickness: Metal 1: $8 \mathrm{k} \AA \pm 0.4 \mathrm{k} \AA \quad$ Thickness: Metal 2: $16 \mathrm{k} \AA \pm 0.8 \mathrm{k} \AA$
GLASSIVATION:
Type: Nitride
Thickness: $4 \mathrm{k} \AA \pm 0.5 \mathrm{k} \AA$
WORST CASE CURRENT DENSITY:
$2.0 \times 10^{5} \mathrm{~A} / \mathrm{cm}^{2}$ at 47.5 mA
TRANSISTOR COUNT: 52
SUBSTRATE POTENTIAL (Powered Up): Floating (Recommend Connection to V-)
Metallization Mask Layout
HFA1113/883


OUT

Test Circuit (Applies to Table 1)


## Test Waveforms

SIMPLIFIED TEST CIRCUIT FOR LARGE AND SMALL SIGNAL PULSE RESPONSE (Applies to Table 3)
$A_{V}=+1$ or +2 TEST CIRCUIT


NOTE:
$V_{S}= \pm 5 V, R_{G}=0 \Omega$ for $A_{V}=+2, R_{G}=\infty$ for $A_{V}=+1$
$R_{F}=$ Internal, $R_{S}=50 \Omega$
$R_{L}=100 \Omega$ For Small and Large Signals
Terminal Numbers Refer to CerDIP Package

LARGE SIGNAL WAVEFORM

$A_{V}=-1$ TEST CIRCUIT


NOTE:
$V_{S}= \pm 5 \mathrm{~V}, \mathrm{~A}_{\mathrm{V}}=-1$
$\mathrm{R}_{\mathrm{F}}=$ Internal
$R_{S}=50 \Omega, R_{L}=100 \Omega$ For Small and Large Signals Terminal Numbers Refer to CerDIP Package

SMALL SIGNAL WAVEFORM


## Burn-In Circuits



NOTES:
R1 $=100 \Omega, \pm 5 \%$ (Per Socket)
C1 $=$ C2 $=0.01 \mu \mathrm{~F}$ (Per Socket) or $0.1 \mu \mathrm{~F}$ (Per Row) Minimum
D1 $=$ D2 $=1$ N4002 or Equivalent (Per Board)
D3 $=$ D4 $=1$ N4002 or Equivalent (Per Socket)
$\mathrm{V}+=+5.5 \mathrm{~V} \pm 0.5 \mathrm{~V}$
$\mathrm{V}-=-5.5 \mathrm{~V} \pm 0.5 \mathrm{~V}$

HFA1113ML/883 CERAMIC LCC


NOTES:
R1 $=1 \mathrm{k} \Omega, \pm 5 \%$ (Per Socket)
R2 $=100 \Omega, \pm 5 \%$ (Per Socket)
$\mathrm{C} 1=\mathrm{C} 2=0.01 \mu \mathrm{~F}$ (Per Socket) or $0.1 \mu \mathrm{~F}$ (Per Row) Minimum
D1 = D2 $=1$ N4002 or Equivalent (Per Board)
D3 $=$ D4 $=1$ N4002 or Equivalent (Per Socket)
$\mathrm{V}+=+5.5 \mathrm{~V} \pm 0.5 \mathrm{~V}$
$\mathrm{V}-=-5.5 \mathrm{~V} \pm 0.5 \mathrm{~V}$

HFA1113/883

## Ceramic Dual-In-Line Frit Seal Packages (CerDIP)



## NOTES:

1. Index area: A notch or a pin one identification mark shall be located adjacent to pin one and shall be located within the shaded area shown. The manufacturer's identification shall not be used as a pin one identification mark.
2. The maximum limits of lead dimensions $b$ and $c$ or $M$ shall be measured at the centroid of the finished lead surfaces, when solder dip or tin plate lead finish is applied.
3. Dimensions b1 and c1 apply to lead base metal only. Dimension $M$ applies to lead plating and finish thickness.
4. Corner leads ( $1, \mathrm{~N}, \mathrm{~N} / 2$, and $\mathrm{N} / 2+1$ ) may be configured with a partial lead paddle. For this configuration dimension b3 replaces dimension b2.

F8.3A MIL-STD-1835 GDIP1-T8 (D-4, CONFIGURATION A) 8 LEAD CERAMIC DUAL-IN-LINE FRIT SEAL PACKAGE

| SYMBOL | INCHES |  | MILLIMETERS |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |  |  |  |  |  |  |  |
| A | - | 0.200 | - | 5.08 | - |  |  |  |  |  |  |
| b | 0.014 | 0.026 | 0.36 | 0.66 | 2 |  |  |  |  |  |  |
| b1 | 0.014 | 0.023 | 0.36 | 0.58 | 3 |  |  |  |  |  |  |
| b2 | 0.045 | 0.065 | 1.14 | 1.65 | - |  |  |  |  |  |  |
| b3 | 0.023 | 0.045 | 0.58 | 1.14 | 4 |  |  |  |  |  |  |
| c | 0.008 | 0.018 | 0.20 | 0.46 | 2 |  |  |  |  |  |  |
| c1 | 0.008 | 0.015 | 0.20 | 0.38 | 3 |  |  |  |  |  |  |
| D | - | 0.405 | - | 10.29 | 5 |  |  |  |  |  |  |
| E | 0.220 | 0.310 | 5.59 | 7.87 | 5 |  |  |  |  |  |  |
| e | 0.100 |  | BSC | 2.54 BSC | - |  |  |  |  |  |  |
| eA | 0.300 |  | BSC | 7.62 BSC | - |  |  |  |  |  |  |
| eA/2 | 0.150 |  | BSC | 3.81 |  |  |  |  |  |  |  |
| BSC | - |  |  |  |  |  |  |  |  |  |  |
| L | 0.125 | 0.200 | 3.18 | 5.08 | - |  |  |  |  |  |  |
| Q | 0.015 | 0.060 | 0.38 | 1.52 | 6 |  |  |  |  |  |  |
| S1 | 0.005 | - | 0.13 | - | 7 |  |  |  |  |  |  |
| $\alpha$ | $90^{\circ}$ | $105^{\circ}$ | $90^{\circ}$ | $105^{\circ}$ | - |  |  |  |  |  |  |
| aaa | - | 0.015 | - | 0.38 | - |  |  |  |  |  |  |
| bbb | - | 0.030 | - | 0.76 | - |  |  |  |  |  |  |
| ccc | - | 0.010 | - | 0.25 | - |  |  |  |  |  |  |
| M | - | 0.0015 | - | 0.038 | 2,3 |  |  |  |  |  |  |
| N | 8 |  |  |  |  |  | 8 |  |  |  | 8 |

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5. This dimension allows for off-center lid, meniscus, and glass overrun.
6. Dimension $Q$ shall be measured from the seating plane to the base plane.
7. Measure dimension S1 at all four corners.
8. N is the maximum number of terminal positions.
9. Dimensioning and tolerancing per ANSI Y14.5M-1982.
10. Controlling dimension: INCH.
11. Materials: Compliant to MIL-I-38535.

HFA1113/883

## Ceramic Leadless Chip Carrier Packages (CLCC)



J20.A MIL-STD-1835 CQCC1-N20 (C-2)
20 PAD LEADLESS CERAMIC CHIP CARRIER

| SYMBOL | INCHES |  | MILLIMETERS |  | NOTES |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |  |
| A | 0.060 | 0.100 | 1.52 | 2.54 | 6, 7 |
| A1 | 0.050 | 0.088 | 1.27 | 2.23 | - |
| B | - | - | - | - | - |
| B1 | 0.022 | 0.028 | 0.56 | 0.71 | 2, 4 |
| B2 | 0.072 REF |  | 1.83 REF |  | - |
| B3 | 0.006 | 0.022 | 0.15 | 0.56 | - |
| D | 0.342 | 0.358 | 8.69 | 9.09 | - |
| D1 | 0.200 BSC |  | 5.08 BSC |  | - |
| D2 | 0.100 BSC |  | 2.54 BSC |  | - |
| D3 | - | 0.358 | - | 9.09 | 2 |
| E | 0.342 | 0.358 | 8.69 | 9.09 | - |
| E1 | 0.200 BSC |  | 5.08 BSC |  | - |
| E2 | 0.100 BSC |  | 2.54 BSC |  | - |
| E3 | - | 0.358 | - | 9.09 | 2 |
| e | 0.050 BSC |  | 1.27 BSC |  | - |
| e1 | 0.015 | - | 0.38 | - | 2 |
| h | 0.040 REF |  | 1.02 REF |  | 5 |
| j | 0.020 REF |  | 0.51 REF |  | 5 |
| L | 0.045 | 0.055 | 1.14 | 1.40 | - |
| L1 | 0.045 | 0.055 | 1.14 | 1.40 | - |
| L2 | 0.075 | 0.095 | 1.91 | 2.41 | - |
| L3 | 0.003 | 0.015 | 0.08 | 0.38 | - |
| ND | 5 |  | 5 |  | 3 |
| NE | 5 |  | 5 |  | 3 |
| N | 20 |  | 20 |  | 3 |

## NOTES:

1. Metallized castellations shall be connected to plane 1 terminals and extend toward plane 2 across at least two layers of ceramic or completely across all of the ceramic layers to make electrical connection with the optional plane 2 terminals.
2. Unless otherwise specified, a minimum clearance of 0.015 inch $(0.38 \mathrm{~mm})$ shall be maintained between all metallized features (e.g., lid, castellations, terminals, thermal pads, etc.)
3. Symbol " $N$ " is the maximum number of terminals. Symbols "ND" and "NE" are the number of terminals along the sides of length "D" and "E", respectively.
4. The required plane 1 terminals and optional plane 2 terminals (if used) shall be electrically connected.
5. The corner shape (square, notch, radius, etc.) may vary at the manufacturer's option, from that shown on the drawing.
6. Chip carriers shall be constructed of a minimum of two ceramic layers.
7. Dimension "A" controls the overall package thickness. The maximum "A" dimension is package height before being solder dipped.
8. Dimensioning and tolerancing per ANSI Y14.5M-1982.
9. Controlling dimension: INCH.
10. Materials: Compliant to MIL-I-38535.

DESIGN INFORMATION
Output Limiting, Ultra High Speed Programmable Gain Buffer Amplifier


## DESIGN INFORMATION (Continued)

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Typical Performance Curves $\mathrm{V}_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, Unless Otherwise Specified (Continued)

UNCLAMPED PERFORMANCE
$\left(A_{V}=+2, V_{H}=2 V, V_{L}=-2 V\right)$


20ns/DIV


FREQUENCY RESPONSE FOR VARIOUS LOAD RESISTORS


CLAMPED PERFORMANCE
( $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\mathrm{H}}=1 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=-1 \mathrm{~V}, 2 \mathrm{X}$ Overdrive)


FREQUENCY RESPONSE FOR VARIOUS LOAD RESISTORS


FREQUENCY RESPONSE FOR VARIOUS LOAD RESISTORS


## DESIGN INFORMATION (continued)

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FREQUENCY RESPONSE FOR VARIOUS OUTPUT VOLTAGES


FREQUENCY RESPONSE FOR VARIOUS OUTPUT VOLTAGES


FULL POWER BANDWIDTH

-3dB BANDWIDTH vs TEMPERATURE


GAIN FLATNESS


## DESIGN INFORMATION (continued)

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DEVIATION FROM LINEAR PHASE


LOW FREQUENCY REVERSE ISOLATION ( $\mathbf{S}_{\mathbf{1 2}}$ )



SETTLING RESPONSE


HIGH FREQUENCY REVERSE ISOLATION ( $\mathbf{S}_{\mathbf{1 2}}$ )


3rd ORDER INTERMODULATION INTERCEPT vs FREQUENCY


## DESIGN INFORMATION (Continued)

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Typical Performance Curves $\mathrm{V}_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, Unless Otherwise Specified (Continued)







## DESIGN INFORMATION (continued)

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Typical Performance Curves $\mathrm{V}_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, Unless Otherwise Specified (Continued)

INTEGRAL LINEARITY ERROR


OVERSHOOT vs INPUT RISE TIME


SUPPLY CURRENT vs SUPPLY VOLTAGE


OVERSHOOT vs INPUT RISE TIME


OVERSHOOT vs INPUT RISE TIME


SUPPLY CURRENT vs TEMPERATURE


## DESIGN INFORMATION (continued)

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Typical Performance Curves $\mathrm{V}_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, Unless Otherwise Specified (Continued)


NON-LINEARITY NEAR CLAMP VOLTAGE
$\left(A_{V}=-1\right)$


V ${ }_{L}$ CLAMP ACCURACY vs OVERDRIVE


INPUT NOISE CHARACTERISTICS

$V_{H}$ CLAMP ACCURACY vs OVERDRIVE

$\mathrm{V}_{\mathrm{H}}$ CLAMP ACCURACY vs OVERDRIVE


## DESIGN INFORMATION (continued)

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Typical Performance Curves $\mathrm{V}_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, Unless Otherwise Specified (Continued)
$V_{L}$ CLAMP ACCURACY vs OVERDRIVE


CLAMP ACCURACY vs TEMPERATURE

$\mathrm{V}_{\mathbf{H}}$ CLAMP INPUT BANDWIDTH


OVERDRIVE RECOVERY vs OVERDRIVE


CLAMP BIAS CURRENT vs TEMPERATURE

$\mathbf{V}_{\mathrm{L}}$ CLAMP INPUT BANDWIDTH


## DESIGN INFORMATION (continued)

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## Application Information

## Closed Loop Gain Selection

The HFA1113 features a novel design which allows the user to select from three closed loop gains, without any external components. The result is a more flexible product, fewer part types in inventory, and more efficient use of board space.
This "buffer" operates in closed loop gains of $-1,+1$, or +2 , and gain selection is accomplished via connections to the $\pm$ Inputs. Applying the input signal to +IN and floating -IN selects a gain of +1 , while grounding -IN selects a gain of +2 . A gain of -1 is obtained by applying the input signal to -IN with +IN grounded.

The table below summarizes these connections:

| COIN <br>  | +INPUT (PIN 3) | -INPUT (PIN 2) |
| :---: | :---: | :---: |
|  | GND | Input |
| +1 | Input | NC (Floating) |
| +2 | Input | GND |

## PC Board Layout

The frequency response of this amplifier depends greatly on the amount of care taken in designing the PC board. The use of low inductance components such as chip resistors and chip capacitors is strongly recommended, while a solid ground plane is a must!
Attention should be given to decoupling the power supplies. A large value $(10 \mu \mathrm{~F})$ tantalum in parallel with a small value $(0.1 \mu \mathrm{~F})$ chip capacitor works well in most cases.
Terminated microstrip signal lines are recommended at the input and output of the device. Capacitance directly on the output must be minimized, or isolated as discussed in the next section.
For unity gain applications, care must also be taken to minimize the capacitance to ground seen by the amplifier's inverting input. At higher frequencies this capacitance will tend to short the -INPUT to GND, resulting in a closed loop gain which increases with frequency. This will cause excessive high frequency peaking and potentially other problems as well.
An example of a good high frequency layout is the Evaluation Board shown in Figure 2.

## Driving Capacitive Loads

Capacitive loads, such as an A/D input, or an improperly terminated transmission line will degrade the amplifier's phase margin resulting in frequency response peaking and possible oscillations. In most cases, the oscillation can be avoided by placing a resistor $\left(\mathrm{R}_{\mathrm{S}}\right)$ in series with the output prior to the capacitance.

Figure 1 details starting points for the selection of this resistor. The points on the curve indicate the $R_{S}$ and $C_{L}$ combinations for the optimum bandwidth, stability, and settling time, but experimental fine tuning is recommended. Picking a point above or to the right of the curve yields an overdamped response, while points below or left of the curve indicate areas of underdamped performance.
$R_{S}$ and $C_{L}$ form a low pass network at the output, thus limiting system bandwidth well below the amplifier bandwidth of 850 MHz . By decreasing $R_{S}$ as $C_{L}$ increases (as illustrated in the curves), the maximum bandwidth is obtained without sacrificing stability. Even so, bandwidth does decrease as you move to the right along the curve. For example, at $A_{V}=+1, R_{S}=50 \Omega, C_{L}=30 \mathrm{pF}$, the overall bandwidth is limited to 300 MHz , and bandwidth drops to 100 MHz at $A_{V}=+1, R_{S}=5 \Omega, C_{L}=340 p F$.


FIGURE 1. RECOMMENDED SERIES OUTPUT RESISTOR vs. LOAD CAPACITANCE

## Evaluation Board

The performance of the HFA1113 may be evaluated using the HFA11XX Evaluation Board, slightly modified as follows:

1. Remove the $500 \Omega$ feedback resistor (R2), and leave the connection open.
2. A. For $A_{V}=+1$ evaluation, remove the $500 \Omega$ gain setting resistor (R1), and leave pin 2 floating.
B. For $A_{V}=+2$, replace the $500 \Omega$ gain setting resistor with a $0 \Omega$ resistor to GND.
The layout and modified schematic of the board are shown in Figure 2.

To order evaluation boards, please contact your local sales office.

## DESIGN INFORMATION (Continued)

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FIGURE 2. EVALUATION BOARD SCHEMATIC AND LAYOUT

## Clamp Operation

## General

The HFA1113 features user programmable output clamps to limit output voltage excursions. Clamping action is obtained by applying voltages to the $\mathrm{V}_{\mathrm{H}}$ and $\mathrm{V}_{\mathrm{L}}$ terminals (DIP pins 8 \& 5) of the amplifier. $\mathrm{V}_{\mathrm{H}}$ sets the upper output limit, while $\mathrm{V}_{\mathrm{L}}$ sets the lower clamp level. If the amplifier tries to drive the output above $\mathrm{V}_{\mathrm{H}}$, or below $\mathrm{V}_{\mathrm{L}}$, the clamp circuitry limits the output voltage at $\mathrm{V}_{\mathrm{H}}$ or $\mathrm{V}_{\mathrm{L}}$ ( $\pm$ the clamp accuracy), respectively. The low input bias currents of the clamp pins allow them to be driven by simple resistive divider circuits, or active elements such as amplifiers or DACs.

## Clamp Circuitry

Figure 3 shows a simplified schematic of the HFA1113 input stage, and the high clamp $\left(\mathrm{V}_{\mathrm{H}}\right)$ circuitry. As with all current feedback amplifiers, there is a unity gain buffer (QX1-QX2) between the positive and negative inputs. This buffer forces -IN to track +IN , and sets up a slewing current of:

$$
\left(V_{-I N}-V_{\text {OUT }}\right) / R_{F}+V_{-I N} / R_{G}
$$

This current is mirrored onto the high impedance node $(Z)$ by QX3-QX4, where it is converted to a voltage and fed to the output via another unity gain buffer. If no clamping is utilized, the high impedance node may swing within the limits defined by QP4 and QN4. Note that when the output reaches it's quiescent value, the current flowing through $-\mathbb{N}$ is reduced to only that small current $\left(-l_{\text {BIAS }}\right)$ required to keep the output at the final voltage.

Tracing the path from $\mathrm{V}_{\mathrm{H}}$ to Z illustrates the effect of the clamp voltage on the high impedance node. $\mathrm{V}_{\mathrm{H}}$ decreases by $2 \mathrm{~V}_{\mathrm{BE}}$ (QN6 and QP6) to set up the base voltage on QP5.


FIGURE 3. HFA1113 SIMPLIFIED $\mathrm{V}_{\mathrm{H}}$ CLAMP CIRCUITRY

QP5 begins to conduct whenever the high impedance node reaches a voltage equal to QP5's base voltage $+2 \mathrm{~V}_{\mathrm{BE}}$ (QP5 and QN5). Thus, QP5 clamps node $Z$ whenever $Z$ reaches $\mathrm{V}_{\mathrm{H}}$. R1 provides a pull-up network to ensure functionality with the clamp inputs floating. A similar description applies to the symmetrical low clamp circuitry controlled by $\mathrm{V}_{\mathrm{L}}$.

When the output is clamped, the negative input continues to source a slewing current (lCLAMP) in an attempt to force the output to the quiescent voltage defined by the input. QP5 must sink this current while clamping, because the -IN current is always mirrored onto the high impedance node. The clamping current is calculated as:
$\mathrm{I}_{\text {CLAMP }}=\left(\mathrm{V}_{\text {-IN }}-\mathrm{V}_{\text {OUT CLAMPED }}\right) / 300 \Omega+\mathrm{V}_{\text {-IN }} / \mathrm{R}_{\mathrm{G}}$. As an example, a unity gain circuit with $\mathrm{V}_{\mathbb{I N}}=2 \mathrm{~V}$, and $\mathrm{V}_{\mathrm{H}}=$ 1 V , would have $\mathrm{I}_{\mathrm{CLAMP}}=(2 \mathrm{~V}-1 \mathrm{~V}) / 300 \Omega+2 \mathrm{~V} / \infty=3.33 \mathrm{~mA}$ ( $\mathrm{R}_{\mathrm{G}}=\infty$ because -IN is floated for unity gain applications). Note that $I_{\text {CC }}$ will increase by $I_{\text {CLAMP }}$ when the output is clamp limited.

## Clamp Accuracy

The clamped output voltage will not be exactly equal to the voltage applied to $\mathrm{V}_{\mathrm{H}}$ or $\mathrm{V}_{\mathrm{L}}$. Offset errors, mostly due to $\mathrm{V}_{\mathrm{BE}}$ mismatches, necessitate a clamp accuracy parameter which is found in the device specifications. Clamp accuracy is a function of the clamping conditions. Referring again to Figure 3 , it can be seen that one component of clamp accuracy is the $\mathrm{V}_{\mathrm{BE}}$ mismatch between the QX6 transistors, and the QX5 transistors. If the transistors always ran at the same current level there would be no $\mathrm{V}_{\mathrm{BE}}$ mismatch, and no contribution to the inaccuracy. The QX6 transistors are biased at a constant current, but as described earlier, the current through QX5 is equivalent to $I_{C L A M P}$. $\mathrm{V}_{\mathrm{BE}}$ increases as $\mathrm{I}_{\text {CLAMP }}$ increases,

## DESIGN INFORMATION (continued)

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causing the clamped output voltage to increase as well. $\mathrm{I}_{\text {CLAMP }}$ is a function of the overdrive level ( $\mathrm{A}_{\mathrm{VCL}} \times \mathrm{V}_{\text {IN }}-\mathrm{V}_{\text {OUT }}$ CLAMPED), so clamp accuracy degrades as the overdrive increases. As an example, the specified accuracy of $\pm 100 \mathrm{mV}$ for a 1.6X overdrive degrades to $\pm 240 \mathrm{mV}$ for a 3 X overdrive.
Consideration must also be given to the fact that the clamp voltages have an affect on amplifier linearity. The "Nonlinearity Near Clamp Voltage" curve in the data sheet illustrates the impact of several clamp levels on linearity.

## Clamp Range

Unlike some competitor devices, both $\mathrm{V}_{\mathrm{H}}$ and $\mathrm{V}_{\mathrm{L}}$ have usable ranges that cross 0 V . While $\mathrm{V}_{\mathrm{H}}$ must be more positive than $\mathrm{V}_{\mathrm{L}}$, both may be positive or negative, within the range restrictions indicated in the specifications. For example, the HFA1113 could be limited to ECL output levels by setting $\mathrm{V}_{\mathrm{H}}=-0.8 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{L}}=-1.8 \mathrm{~V} . \mathrm{V}_{\mathrm{H}}$ and $\mathrm{V}_{\mathrm{L}}$ may be connected to the same voltage (GND for instance) but the result won't be a DC output voltage from an AC input signal. A $150-200 \mathrm{mV}$ AC signal will still be present at the output.

## Recovery from Overdrive

The output voltage remains at the clamp level as long as the overdrive condition remains. When the input voltage drops below the overdrive level ( $\mathrm{V}_{\mathrm{CLAMP}}$ / $\mathrm{A}_{\mathrm{VCL}}$ ) the amplifier will return to linear operation. A time delay, known as the Overdrive Recovery Time, is required for this resumption of linear operation. The plots of "Unclamped Performance" and "Clamped Performance" highlight the HFA1113's subnanosecond recovery time. The difference between the unclamped and clamped propagation delays is the overdrive recovery time. The appropriate propagation delays are 8.0ns for the unclamped pulse, and 8.8 ns for the clamped ( 2 X overdrive) pulse yielding an overdrive recovery time of 800ps. The measurement uses the $90 \%$ point of the output transition to ensure that linear operation has resumed. Note: The propagation delay illustrated is dominated by the fixturing. The delta shown is accurate, but the true HFA1113 propagation delay is 500 ps .

TYPICAL PERFORMANCE CHARACTERISTICS
Device Characterized at: $\mathrm{V}_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, \mathrm{~A}_{\mathrm{V}}=+2 \mathrm{~V} / \mathrm{V}, \mathrm{R}_{\mathrm{L}}=100 \Omega$, Unless Otherwise Specified.

| PARAMETERS | CONDITIONS | TEMPERATURE | TYPICAL | UNITS |
| :---: | :---: | :---: | :---: | :---: |
| Output Offset Voltage | $\mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V}$ | $+25^{\circ} \mathrm{C}$ | 8 | mV |
| Average Offset Voltage Drift | Versus Temperature | Full | 10 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| +Input Current | $\mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V}$ | $+25^{\circ} \mathrm{C}$ | 25 | $\mu \mathrm{A}$ |
| +Input Resistance | $\mathrm{A}_{\mathrm{V}}=+1, \Delta \mathrm{~V}_{\mathrm{CM}}=2 \mathrm{~V}$ | $+25^{\circ} \mathrm{C}$ | 50 | $\mathrm{k} \Omega$ |
| -Input Resistance |  | $+25^{\circ} \mathrm{C}$ | 300 | $\Omega$ |
| + Input Noise Voltage * | $\mathrm{f}=100 \mathrm{kHz}$ | $+25^{\circ} \mathrm{C}$ | 9 | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| +Input Noise Current * | $\mathrm{f}=100 \mathrm{kHz}$ | $+25^{\circ} \mathrm{C}$ | 37 | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Input Common Mode Range |  | Full | $\pm 2.8$ | V |
| Input Capacitance |  | $+25^{\circ} \mathrm{C}$ | 2.2 | pF |
| Gain | $\mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {IN }}=2 \mathrm{~V}$ | $+25^{\circ} \mathrm{C}$ | 0.99 | V/V |
| Gain | $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {IN }}=1 \mathrm{~V}$ | $+25^{\circ} \mathrm{C}$ | 1.98 | V/V |
| DC Non-Linearity * | $\mathrm{V}_{\text {OUT }}= \pm 2 \mathrm{~V}$ Full Scale | $+25^{\circ} \mathrm{C}$ | 0.02 | \% |
| Output Voltage * | $A_{V}=-1, R_{L}=100 \Omega$ | $+25^{\circ} \mathrm{C}$ | $\pm 3.3$ | V |
|  | $A_{V}=-1, R_{L}=100 \Omega$ | Full | $\pm 3.0$ | V |
| Output Current * | $A_{V}=-1, R_{L}=50 \Omega$ | $+25^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 60$ | mA |
|  | $A_{V}=-1, R_{L}=50 \Omega$ | $-55^{\circ} \mathrm{C}$ to $0^{\circ} \mathrm{C}$ | $\pm 50$ | mA |
| DC Closed Loop Output Resistance |  | $+25^{\circ} \mathrm{C}$ | 0.3 | $\Omega$ |
| Quiescent Supply Current * | $\mathrm{R}_{\mathrm{L}}=$ Open | Full | 24 | mA |
| -3dB Bandwidth * | $\mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=200 \mathrm{mV} \mathrm{P}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | 800 | MHz |
|  | $\mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=200 \mathrm{mV} \mathrm{V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | 850 | MHz |
|  | $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=200 \mathrm{mV} \mathrm{V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | 550 | MHz |

## DESIGN INFORMATION (continued)

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## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

Device Characterized at: $V_{S U P P L Y}= \pm 5 \mathrm{~V}, A_{V}=+2 \mathrm{~V} / \mathrm{V}, R_{\mathrm{L}}=100 \Omega$, Unless Otherwise Specified.

| PARAMETERS | CONDITIONS | TEMPERATURE | TYPICAL | UNITS |
| :---: | :---: | :---: | :---: | :---: |
| Slew Rate | $\mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=5 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | 2400 | V/us |
|  | $\mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=5 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | 1500 | V/us |
|  | $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=5 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | 1900 | V/us |
| Full Power Bandwidth (Note 1) | $A_{V}=-1, V_{\text {OUT }}=5 V_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | 300 | MHz |
|  | $\mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=5 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | 150 | MHz |
|  | $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=5 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | 220 | MHz |
| Gain Flatness (Note 1) | To $30 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=-1$ | $+25^{\circ} \mathrm{C}$ | $\pm 0.02$ | dB |
|  | To 30 MHz , $\mathrm{A}_{\mathrm{V}}=+1$ | $+25^{\circ} \mathrm{C}$ | $\pm 0.10$ | dB |
|  | To $30 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=+2$ | $+25^{\circ} \mathrm{C}$ | $\pm 0.015$ | dB |
| Gain Flatness (Note 1) | To $50 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=-1$ | $+25^{\circ} \mathrm{C}$ | $\pm 0.05$ | dB |
|  | To 50 MHz , $\mathrm{A}_{V}=+1$ | $+25^{\circ} \mathrm{C}$ | $\pm 0.20$ | dB |
|  | To 50 MHz , $\mathrm{A}_{\mathrm{V}}=+2$ | $+25^{\circ} \mathrm{C}$ | $\pm 0.036$ | dB |
| Gain Flatness (Note 1) | To $100 \mathrm{MHz}, \mathrm{A}_{V}=-1$ | $+25^{\circ} \mathrm{C}$ | $\pm 0.10$ | dB |
|  | To $100 \mathrm{MHz}, \mathrm{A}_{V}=+2$ | $+25^{\circ} \mathrm{C}$ | $\pm 0.07$ | dB |
| Linear Phase Deviation (Note 1) | To $100 \mathrm{MHz}, \mathrm{A}_{V}=-1$ | $+25^{\circ} \mathrm{C}$ | $\pm 0.13$ | Degrees |
|  | To $100 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=+1$ | $+25^{\circ} \mathrm{C}$ | $\pm 0.83$ | Degrees |
|  | To $100 \mathrm{MHz}, \mathrm{A}_{V}=+2$ | $+25^{\circ} \mathrm{C}$ | $\pm 0.05$ | Degrees |
| 2nd Harmonic Distortion (Note 1) | $30 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -52 | dBc |
|  | $30 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -57 | dBc |
|  | $30 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -52 | dBc |
| 3rd Harmonic Distortion (Note 1) | $30 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -71 | dBc |
|  | $30 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -73 | dBc |
|  | $30 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -72 | dBc |
| 2nd Harmonic Distortion (Note 1) | $50 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -47 | dBc |
|  | $50 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -53 | dBc |
|  | $50 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -47 | dBc |
| 3rd Harmonic Distortion (Note 1) | $50 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -63 | dBc |
|  | $50 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -68 | dBc |
|  | $50 \mathrm{MHz}, \mathrm{A}_{V}=+2, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -65 | dBc |
| 2nd Harmonic Distortion (Note 1) | $100 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -41 | dBc |
|  | $100 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -50 | dBc |
|  | $100 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -42 | dBc |
| 3rd Harmonic Distortion (Note 1) | $100 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -55 | dBc |
|  | $100 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -49 | dBc |
|  | $100 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | -62 | dBc |

## DESIGN INFORMATION (continued)

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## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

Device Characterized at: $V_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, \mathrm{~A}_{\mathrm{V}}=+2 \mathrm{~V} / \mathrm{V}, \mathrm{R}_{\mathrm{L}}=100 \Omega$, Unless Otherwise Specified.

| PARAMETERS | CONDITIONS | TEMPERATURE | TYPICAL | UNITS |
| :---: | :---: | :---: | :---: | :---: |
| 3rd Order Intercept (Note 1) | 100MHz | $+25^{\circ} \mathrm{C}$ | 28 | dBm |
|  | 300 MHz | $+25^{\circ} \mathrm{C}$ | 13 | dBm |
| 1dB Compression (Note 1) | 100 MHz | $+25^{\circ} \mathrm{C}$ | 19 | dBm |
|  | 300 MHz | $+25^{\circ} \mathrm{C}$ | 12 | dBm |
| Reverse Isolation ( $\mathrm{S}_{12}$ ) (Note 1) | 40 MHz | $+25^{\circ} \mathrm{C}$ | -70 | dB |
|  | 100 MHz | $+25^{\circ} \mathrm{C}$ | -60 | dB |
|  | 600MHz | $+25^{\circ} \mathrm{C}$ | -32 | dB |
| Rise and Fall Time | $\mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | 500 | ps |
|  | $\mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | 480 | ps |
|  | $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}$ | $+25^{\circ} \mathrm{C}$ | 700 | ps |
| Overshoot (Note 1) | $\mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\text {P-P }}$ | $+25^{\circ} \mathrm{C}$ | 12 | \% |
|  | $\mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}$ | $+25^{\circ} \mathrm{C}$ | 45 | \% |
|  | $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}$ | $+25^{\circ} \mathrm{C}$ | 6 | \% |
| Settling Time (Note 1) | $\mathrm{A}_{\mathrm{V}}=+2$, to $0.1 \%, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}$ to 0 V | $+25^{\circ} \mathrm{C}$ | 13 | ns |
|  | $\mathrm{A}_{\mathrm{V}}=+2$, to $0.05 \%, \mathrm{~V}_{\text {Out }}=2 \mathrm{~V}$ to 0 V | $+25^{\circ} \mathrm{C}$ | 20 | ns |
|  | $\mathrm{A}_{\mathrm{V}}=+2$, to $0.02 \%, \mathrm{~V}_{\text {Out }}=2 \mathrm{~V}$ to 0 V | $+25^{\circ} \mathrm{C}$ | 36 | ns |
| Differential Gain | $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{R}_{\mathrm{L}}=150 \Omega$, NTSC | $+25^{\circ} \mathrm{C}$ | 0.02 | \% |
| Differential Phase | $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{R}_{\mathrm{L}}=150 \Omega$, NTSC | $+25^{\circ} \mathrm{C}$ | 0.04 | Degrees |
| Overdrive Recovery Time, (2X Overdrive) | $\mathrm{V}_{\text {IN }}= \pm 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}}=+1 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=-1 \mathrm{~V}$ | $+25^{\circ} \mathrm{C}$ | 0.75 | ns |
| Clamp Accuracy | $\begin{aligned} & \mathrm{A}_{\mathrm{V}}=-1, \mathrm{~V}_{\mathrm{IN}}= \pm 1.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}}=+1 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{L}}=-1 \mathrm{~V} \end{aligned}$ | $+25^{\circ} \mathrm{C}$ | $\pm 100$ | mV |
| Clamped Overshoot | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}= \pm 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}}=+1 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=-1 \mathrm{~V}, \\ & \text { Input } \mathrm{t}_{\mathrm{R}} / \mathrm{t}_{\mathrm{F}}=2 \mathrm{~ns} \end{aligned}$ | $+25^{\circ} \mathrm{C}$ | 7 | \% |
| Negative Clamp Range ( $\mathrm{V}_{\mathrm{L}}$ ) |  | $+25^{\circ} \mathrm{C}$ | -5.0 to +2.0 | V |
| Positive Clamp Range ( $\mathrm{V}_{\mathrm{H}}$ ) |  | $+25^{\circ} \mathrm{C}$ | -2.0 to +5.0 | V |
| Clamp Input Bias Current | $\mathrm{V}_{\mathrm{H}}=+1 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=-1 \mathrm{~V}$ | $+25^{\circ} \mathrm{C}$ | 50 | $\mu \mathrm{A}$ |
| Clamp Input Bandwidth | $\mathrm{V}_{1 \mathrm{IN}}= \pm 100 \mathrm{mV}, \mathrm{V}_{\mathrm{H}}$ or $\mathrm{V}_{\mathrm{L}}=100 \mathrm{mV} \mathrm{V}_{\mathrm{P}-\mathrm{P}}$ | $+25^{\circ} \mathrm{C}$ | 500 | MHz |

NOTE:

1. See Typical Performance Curves for more information.

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